Si2392ADS

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Marking code: G2

PRODUCT SUMMARY					
V _{DS} (V)	100				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.126				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 6 V	0.144				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.189				
Q _g typ. (nC)	2.9				
I _D (A) ^a	3.1				
Configuration	Single				

FEATURES

N-Channel 100 V (D-S) MOSFET

- TrenchFET[®] power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

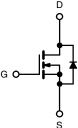
APPLICATIONS

- DC/DC converters / boost converters
- · Load switch
- LED backlighting in LCD TVs
- · Power management for mobile computing



COMPLIANT





N-Channel MOSFET

ORDERING INFORMATION

Package	SOT-23
Lead (Pb)-free and halogen-free	Si2392ADS-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T _A = PARAMETER	SYMBOL	UNIT		
Drain-source voltage		V _{DS}	LIMIT 100	0.111
Gate-source voltage		V _{GS}	± 20	- V
	T _C = 25 °C	•65	3.1	
Continuous drain current (T _J = 150 °C)	T _C = 70 °C		2.5	
	T _A = 25 °C	I _D	2.2 ^{b, c}	
	T _A = 70 °C		1.8 ^{b, c}	
Pulsed drain current (t = 300 µs)		I _{DM}	8	— A
Continuous source-drain diode current	T _C = 25 °C	1	2.1	
	T _A = 25 °C	I _S	1 ^{b, c}	
Single pulse avalanche current	L = 0.1 mH	I _{AS}	3	
Single pulse avalanche energy	L = 0.1 MH	E _{AS}	0.45	mJ
	T _C = 25 °C		2.5	
Maximum power dissipation	T _C = 70 °C	PD	1.6	w
	T _A = 25 °C	гD	1.25 ^{b, c}	~~~
	T _A = 70 °C		0.8 ^{b, c}	
Operating junction and storage temperature range	TJ, T _{stg}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, d	t ≤ 5 s	R _{thJA}	75	100	°C/W	
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	40	50	0/10	

Notes

a. Based on T_C = 25 °C

b. Surface mounted on 1" x 1" FR4 board

c. t = 5 s

d. Maximum under steady state conditions is 166 °C/W

S14-0909-Rev. A, 28-Apr-14

1

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \ \mu\text{A}$	100	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA	-	59	-	mV/°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-4.8	-	mv/ C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.2	-	3	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA	
Zeve este veltere durie sumert		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1		
Zero gate voltage drain current	IDSS	V_{DS} = 100 V, V_{GS} = 0 V, T_{J} = 55 °C	-	-	10	μA	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	5	-	-	А	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2 \text{ A}$	-	0.102	0.126		
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 6 V, I_D = 1 A$	-	0.120	0.144	Ω	
		V _{GS} = 4.5 V, I _D = 1 A	-	0.135	0.189		
Forward transconductance ^a g_{fs} $V_{DS} = 20 V, I_D = 2 A$		-	5	-	S		
Dynamic ^b					1		
Input capacitance	C _{iss}		-	196	-	1	
Output capacitance	C _{oss}	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	67	-	pF	
Reverse transfer capacitance	C _{rss}		-	14	-		
	$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 2.2 \text{ A}$		-	5.2	10.4	1	
Total gate charge	Qg		-	2.9	5.8	- nC	
Gate-source charge	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 2.2 \text{ A}$	-	1	-		
Gate-drain charge	Q _{gd}		-	1.4	-		
Gate resistance	R _g	f = 1 MHz	0.9	4.3	8.6	Ω	
Turn-on delay time	t _{d(on)}		-	40	60		
Rise time	tr	$V_{DD} = 50 \text{ V}, \text{ R}_{\text{L}} = 27.7 \Omega$	-	68	102	-	
Turn-off delay time	t _{d(off)}	$I_D = 1.8 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	14	21		
Fall time	t _f		-	20	30		
Turn-on delay time	t _{d(on)}		-	8	16	ns	
Rise time	tr	$V_{DD} = 50 \text{ V}, \text{ R}_{\text{L}} = 27.7 \Omega$	-	10	20	1	
Turn-off delay time	t _{d(off)}	$I_D = 1.8 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	_	10	20		
Fall time	t _f		_	7	14		
Drain-Source Body Diode Characterist	ics		1	1		•	
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	2.1		
Pulse diode forward current ^a	I _{SM}	-	-	- 1	8	A	
Body diode voltage	V _{SD}	I _S = 1.8 A	-	0.8	1.2	V	
Body diode reverse recovery time	t _{rr}	č	-	23	35	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 1.8 A, di/dt = 100 A/μs,	-	21	32	nC	
Reverse recovery fall time	ta	$T_{\rm J} = 25 ^{\circ}{\rm C}$	-	17	-		
Reverse recovery rise time	t _b		_	6		ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

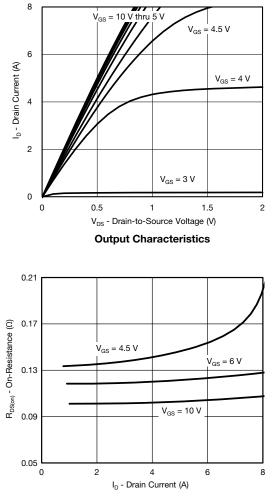
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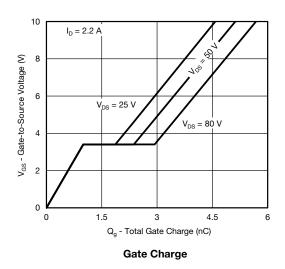
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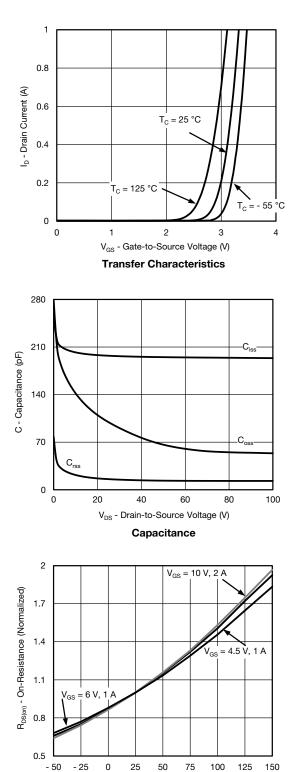
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



On-Resistance vs. Drain Current and Gate Voltage





T_J - Junction Temperature (°C) On-Resistance vs. Junction Temperature

S14-0909-Rev. A, 28-Apr-14

3

Document Number: 62960

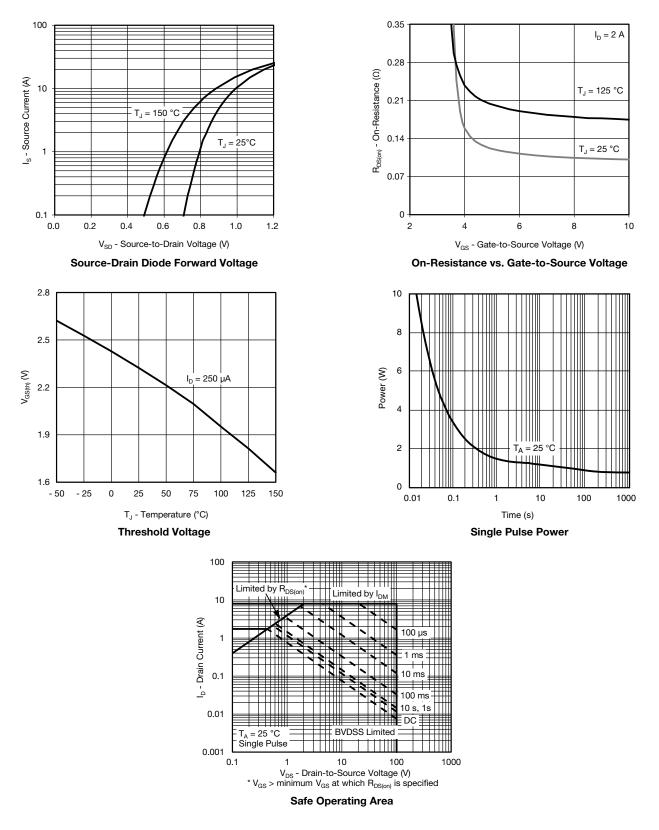
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

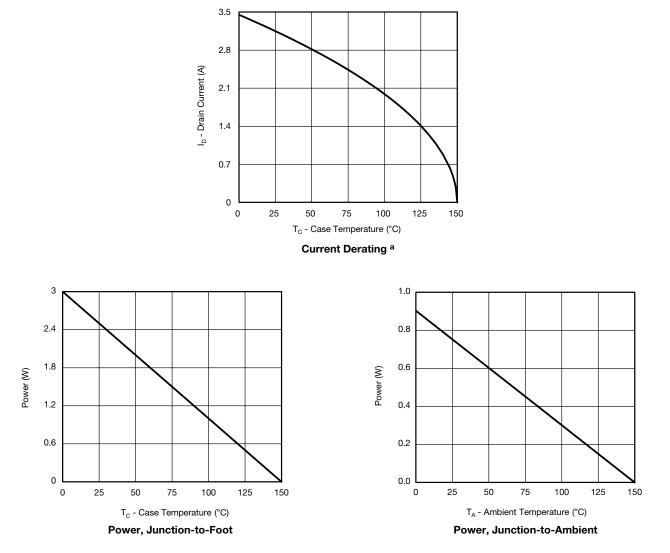


4



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note

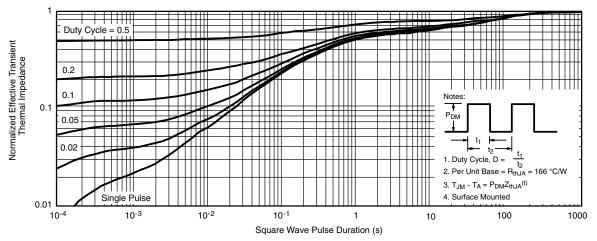
a. The power dissipation P_D is based on T_J max.= 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

5

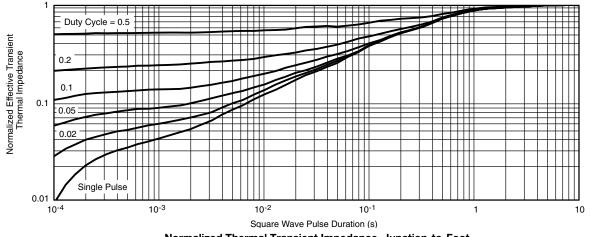


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62960.



Package Information

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SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	METERS	INCHES			
Dim	Min	Max	Min	Мах		
Α	0.89	1.12	0.035	0.044		
A ₁	0.01	0.10	0.0004	0.004		
A ₂	0.88	1.02	0.0346	0.040		
b	0.35	0.50	0.014	0.020		
С	0.085	0.18	0.003	0.007		
D	2.80	3.04	0.110	0.120		
E	2.10	2.64	0.083	0.104		
E ₁	1.20	1.40	0.047	0.055		
е	0.95	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref			
L	0.40	0.60	0.016	0.024		
L ₁	0.64 Ref		0.025 Ref			
S	0.50 Ref		0.020 Ref			
q	3°	8°	3°	8°		



Application Note 826

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RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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Revision: 01-Jan-2024